



NOTES:

1. MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:NATURAL.
 - 1.2 CONTACT: COPPER ALLOY
 - 1.3 FITTING NAIL: COPPER ALLOY
- △ 2. FINISH:
 - 2.1 CONTACT:
 - UNDERPLATING: 30u"~80u" MIN. NICKEL OVERALL.
 - FINISH: 8:GOLD FLASH OVER ALL
 - GOLD 3u" MIN. ON CONTACT
 - M:GOLD 3u" MIN. ON CONTACT AND SOLDER FOR SELECTIVENESS
 - 2.2 FITTING NAIL:
 - UNDERPLATING: 30u"~80u" MIN. NICKEL OVERALL.
 - FINISH: 8:GOLD FLASH OVER ALL
 - GOLD 3u" MIN. ON CONTACT
 - M:GOLD 3u" MIN. ON CONTACT AND SOLDER FOR SELECTIVENESS
3. REFLOW SOLDER CAPABLE TO 260°C

RoHS Compliant

All Connectors

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DRAWING BY CY		TOLERANCES ARE X ± 0.50 .X ± 0.25 .XX ± 0.15 .XXX ± 0.10 ANG ±
CHECKED BY GENIUS		
UNIT/ mm	SCALE 1 : 1	
DATE		
SIZE A4	PJECTION	



ORDER INFORMATION

MXM-W095EP2-24206-LF

SERIES 90°SMT HIGH 9.5mm EAR+POST/2 24+206 PIN LEADFREE

W/O LOCATING PEG

DESCRIPTION: MXM 230 pins 0.5mm pitch Edge Card Conn. R/A D/R STD H=9.5mm (BTB H=7.0)